



Welcome to [E-XFL.COM](#)

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Discontinued at Digi-Key
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	CANbus, EBI/EMI, I ² C, LINbus, SCI, SPI, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	111
Program Memory Size	768KB (768K x 8)
Program Memory Type	FLASH
EEPROM Size	32K x 8
RAM Size	128K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x10b, 21x12b; D/A 2x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	144-LQFP
Supplier Device Package	144-LFQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f5631addfb-v0

Table 1.4 Pin Functions (2/6)

Classifications	Pin Name	I/O	Description
Bus control	RD#	Output	Strobe signal which indicates that reading from the external bus interface space is in progress.
	WR#	Output	Strobe signal which indicates that writing to the external bus interface space is in progress, in 1-write strobe mode.
	WR0# to WR3#	Output	Strobe signals which indicate that either group of data bus pins (D7 to D0, D15 to D8, D23 to D16, and D31 to D24) is valid in writing to the external bus interface space, in byte strobe mode.
	BC0# to BC3#	Output	Strobe signals which indicate that either group of data bus pins (D7 to D0, D15 to D8, D23 to D16, and D31 to D24) is valid in access to the external bus interface space, in 1-write strobe mode.
	ALE	Output	Address latch signal when address/data multiplexed bus is selected.
	CKE	Output	Output pin for SDRAM clock enable signals.
	SDCS#	Output	Output pin for SDRAM chip select signals.
	RAS#	Output	Output pin for SDRAM row address strobe signals.
	CAS#	Output	Output pin for SDRAM column address strobe signals.
	WE#	Output	Output pin for SDRAM write enable signals.
	DQM0 to DQM3	Output	Output pins for SDRAM I/O data mask enable signals.
	CS0# to CS7#	Output	Select signals for CS area.
	WAIT#	Input	Input pins for wait request signals in access to the external space.
EXDMA controller	EDREQ0, EDREQ1		Input pins for external DMA transfer requests.
	EDACK0, EDACK1		Output pins for single address transfer acknowledge signals.
Interrupt	NMI	Input	Non-maskable interrupt request signal.
	IRQ0 to IRQ15	Input	Maskable interrupt request signals.
Multi-function timer pulse unit 2	MTIOC0A, MTIOC0B MTIOC0C, MTIOC0D	I/O	The TGRA0 to TGRD0 input capture input/output compare output/PWM output pins.
	MTIOC1A, MTIOC1B	I/O	The TGRA1 and TGRB1 input capture input/output compare output/PWM output pins.
	MTIOC2A, MTIOC2B	I/O	The TGRA2 and TGRB2 input capture input/output compare output/PWM output pins.
	MTIOC3A, MTIOC3B MTIOC3C, MTIOC3D	I/O	The TGRA3 to TGRD3 input capture input/output compare output/PWM output pins.
	MTIOC4A, MTIOC4B MTIOC4C, MTIOC4D	I/O	The TGRA4 to TGRD4 input capture input/output compare output/PWM output pins.
	MTIC5U, MTIC5V MTIC5W	Input	The TGRU5, TGRV5, and TGRW5 input capture input/dead time compensation input pins.
	MTCLKA, MTCLKB MTCLKC, MTCLKD	Input	Input pins for external clock signals.
Port output enable 2	POE0# to POE3# POE8#	Input	Input pins for request signals to place the MTU large-current pins in the high impedance state.

Table 1.4 Pin Functions (6/6)

Classifications	Pin Name	I/O	Description
Analog power supply	AVCC0	Input	Analog voltage supply pin for the 12-bit A/D converter. Connect this pin to VCC if the 12-bit A/D converter is not to be used.
	AVSS0	Input	Analog ground pin for the 12-bit A/D converter. Connect this pin to VSS if the 12-bit A/D converter is not to be used.
	VREFH0	Input	Analog reference voltage supply pin for the 12-bit A/D converter. Connect this pin to VCC if the 12-bit A/D converter is not to be used.
	VREFL0	Input	Analog reference ground pin for the 12-bit A/D converter. Connect this pin to VSS if the 12-bit A/D converter is not to be used.
	VREFH	Input	Reference voltage input pin for the 10-bit A/D converter and D/A converter. This is used as the analog power supply for the respective modules. Connect this pin to VCC if neither the 10-bit A/D converter nor the D/A converter is in use.
	VREFL	Input	Reference ground pin for the 10-bit A/D converter and D/A converter. This is used as the analog ground for the respective modules. Set this pin to the same potential as the VSS pin.
I/O ports	P00 to P03, P05, P07	I/O	6-bit input/output pins.
	P10 to P17	I/O	8-bit input/output pins.
	P20 to P27	I/O	8-bit input/output pins.
	P30 to P37	I/O	8-bit input/output pins. (P35 is an input pin)
	P40 to P47	I/O	8-bit input/output pins.
	P50 to P57	I/O	8-bit input/output pins.
	P60 to P67	I/O	8-bit input/output pins.
	P70 to P77	I/O	8-bit input/output pins.
	P80 to P87	I/O	8-bit input/output pins.
	P90 to P97	I/O	8-bit input/output pins.
	PA0 to PA7	I/O	8-bit input/output pins.
	PB0 to PB7	I/O	8-bit input/output pins.
	PC0 to PC7	I/O	8-bit input/output pins.
	PD0 to PD7	I/O	8-bit input/output pins.
	PE0 to PE7	I/O	8-bit input/output pins.
	PF0 to PF5	I/O	6-bit input/output pins.
	PG0 to PG7	I/O	8-bit input/output pins.
	PJ3, PJ5	I/O	2-bit input/output pins.

	A	B	C	D	E	F	G	H	J	K	L	M	N	
13	PE3	PE4	VSS	PE6	P67	PA2	PA4	PA7	PB1	PB5	VSS	VCC	P74	13
12	PE1	PE2	P70	PE5	P65	PA1	VCC	PB0	PB2	PB6	P73	PC1	P75	12
11	P62	P61	PE0	VCC	P66	VSS	PA6	P71	PB4	PB7	PC2	PC0	PC3	11
10	VSS	VCC	P63	PE7	PA0	PA3	PA5	P72	PB3	P76	PC4	P77	P82	10
9	PD6	PD4	PD7	P64	RX63N Group RX631 Group PTLG0145KA-A (145-pin TFLGA) (Top perspective view)					P80	PC5	P81	PC7	9
8	PD2	PD0	PD3	P60						VCC	P83	PC6	VSS	8
7	P92	P91	PD1	PD5						P51	P52	P50	P55	7
6	P90	P47	VSS	P93						P53	P56	VSS_ USB	USB0_ DP	6
5	P45	P43	P46	VCC	P44					P54	P13	VCC_ USB	USB0_ DM	5
4	P42	VREFL0	P41	P01	EMLE	VBATT	BSCANP	P35	P30	P15	P24	P12	P14	4
3	P40	P05	VREFH0	P03	PJ5	PJ3	MD/ FINED	VSS	P32	P31	P16	P86	P87	3
2	P07	AVCC0	P02	PF5	VCL	XCOUT	RES#	VCC	P33	P26	P23	P17	P20	2
1	AVSS0	VREFH	VREFL	P00	VSS	XCIN	XTAL	EXTAL	P34	P27	P25	P22	P21	1
	A	B	C	D	E	F	G	H	J	K	L	M	N	

Note: This figure indicates the power supply pins and I/O port pins. For the pin configuration, see Table 1.7, List of Pins and Pin Functions (145-Pin TFLGA).

Figure 1.6 Pin Assignment (145-Pin TFLGA)



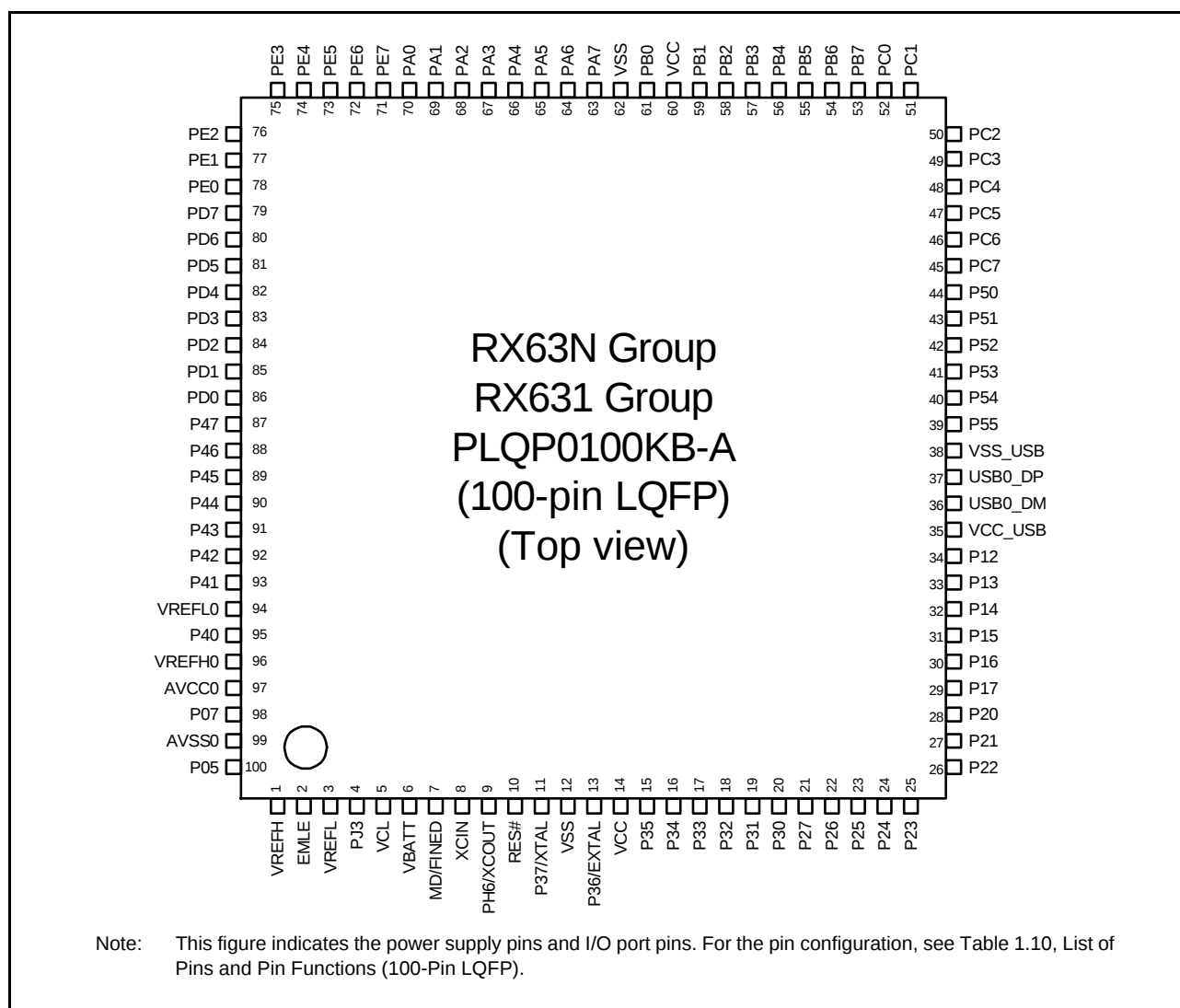
**Figure 1.9 Pin Assignment (100-Pin LQFP)**

Table 1.5 List of Pin and Pin Functions (177-Pin TFLGA, 176-Pin LFBGA) (1/5)

Pin Number 177-Pin TFLGA 176-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIC, SCID, RSPI, RIIC, CAN, IEB, USB, and PDC)	Interrupt	S12AD, AD, DA
A1	AVSS0						
A2	AVCC0						
A3	VREFL0						
A4		P42				IRQ10-DS	AN002
A5		P46				IRQ14-DS	AN006
A6	VCC						
A7	VSS						
A8		P94	A20/D20				
A9	VCC						
A10		P97	A23/D23				
A11		PD6	D6[A6/D6]	MTIC5V/POE1#	SSLC2	IRQ6	AN6
A12		P60	CS0#				
A13		P63	CS3#/CAS#				
A14		PE1	D9[A9/D9]	MTIOC4C/TIOCD9/PO18	TXD12/SMOSI12/ SSDA12/TXDX12/ SIOX12/SSLB2/RSPCKB		ANEX1
A15		PE2	D10[A10/D10]	MTIOC4A/TIOCA9/PO23	RXD12/SMISO12/ SSCL12/RXDX12/SSLB3/ MOSIB	IRQ7-DS	AN0
B1		P05				IRQ13	DA1
B2		P07				IRQ15	ADTRG0#
B3		P40				IRQ8-DS	AN000
B4		P41				IRQ9-DS	AN001
B5		P47				IRQ15-DS	AN007
B6		P91	A17/D17		SCK7		AN015
B7		P92	A18/D18		RXD7/SMISO7/SSCL7		AN016
B8		PD1	D1[A1/D1]	MTIOC4B/TIOCB7/ TCLKG	MOSIC/CTX0	IRQ1	AN009
B9		P96	A22/D22				
B10		PD4	D4[A4/D4]	POE3#	SSLC0	IRQ4	AN012
B11		PG1	D25				
B12	VSS						
B13		P64	CS4#/WE#				
B14		PE0	D8[A8/D8]	TIOCC9	SCK12/SSLB1		ANEX0
B15		PE3	D11[A11/D11]	MTIOC4B/TIOCB9/PO26/ POE8#	ET_ERXD3/CTS12#/ RTS12#/SS12#/MISOB		AN1
C1	VREFL						
C2	VREFH						
C3	VREFH0						
C4		P43				IRQ11-DS	AN003
C5		P45				IRQ13-DS	AN005
C6		P90	A16/D16		TXD7/SMOSI7/SSDA7		AN014
C7		PD0	D0[A0/D0]	TIOCA7		IRQ0	AN008
C8		PD2	D2[A2/D2]	MTIOC4D/TIOCA8	MISOC/CRX0	IRQ2	AN010
C9		PD3	D3[A3/D3]	TIOCB8/TCLKH/POE8#	RSPCKC	IRQ3	AN011
C10		PG0	D24				
C11	VCC						
C12		P62	CS2#/RAS#				
C13		PE4	D12[A12/D12]	MTIOC4D/MTIOC1A/ TIOCA10/PO28	ET_ERXD2/SSLB0		AN2

Table 1.9 List of Pins and Pin Functions (100-Pin TFLGA) (1/5)

Pin No. 100-pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC	Timers (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SC1c, SC1d, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12AD AD DA
A1		P05				IRQ13	DA1
A2	VREFH						
A3		P07				IRQ15	ADTRG0#
A4	VREFL0						
A5		P43				IRQ11-DS	AN003
A6		PD0	D0[A0/D0]			IRQ0	AN008
A7		PD4	D4[A4/D4]	POE3#		IRQ4	AN012
A8		PE0	D8[A8/D8]		SCK12/SSLB1		ANEX0
A9		PE1	D9[A9/D9]	MTIOC4C/ PO18	TXD12/SMOSI12/ SSDA12/TXDX12/ SIOX12/SSLB2/ RSPCKB		ANEX1
A10		PE2	D10[A10/D10]	MTIOC4A/ PO23	RXD12/SMISO12/ SSCL12/RXDX12/ SSLB3/MOSIB	IRQ7-DS	AN0
B1	EMLE						
B2	AVSS0						
B3	AVCC0						
B4		P40				IRQ8-DS	AN000
B5		P44				IRQ12-DS	AN004
B6		PD1	D1[A1/D1]	MTIOC4B	CTX0*1	IRQ1	AN009
B7		PD3	D3[A3/D3]	POE8#		IRQ3	AN011
B8		PD6	D6[A6/D6]	MTIC5V/ POE1#		IRQ6	AN6
B9		PD7	D7[A7/D7]	MTIC5U/ POE0#		IRQ7	AN7
B10		PE3	D11[A11/D11]	MTIOC4B/ PO26/POE8#	CTS12#/RTS12#/ SS12#/MISOB/ ET_ERXD3		AN1
C1	VCL						
C2	VREFL						
C3		PJ3		MTIOC3C	CTS6#/RTS6#/ CTS0#/RTS0#/ SS6#/SS0#		
C4	VREFH0						
C5		P42				IRQ10-DS	AN002
C6		P47				IRQ15-DS	AN007
C7		PD2	D2[A2/D2]	MTIOC4D	CRX0*1	IRQ2	AN010
C8		PD5	D5[A5/D5]	MTIC5W/ POE2#		IRQ5	AN013
C9		PE5	D13[A13/D13]	MTIOC4C/ MTIOC2B	RSPCKB/ ET_RX_CLK/ REF50CK	IRQ5	AN3
C10		PE4	D12[A12/D12]	MTIOC4D/ MTIOC1A/ PO28	SSLB0/ET_ERXD2		AN2
D1	XCIN						

2. CPU

The RX CPU has sixteen general-purpose registers, nine control registers, and one accumulator used for DSP instructions.

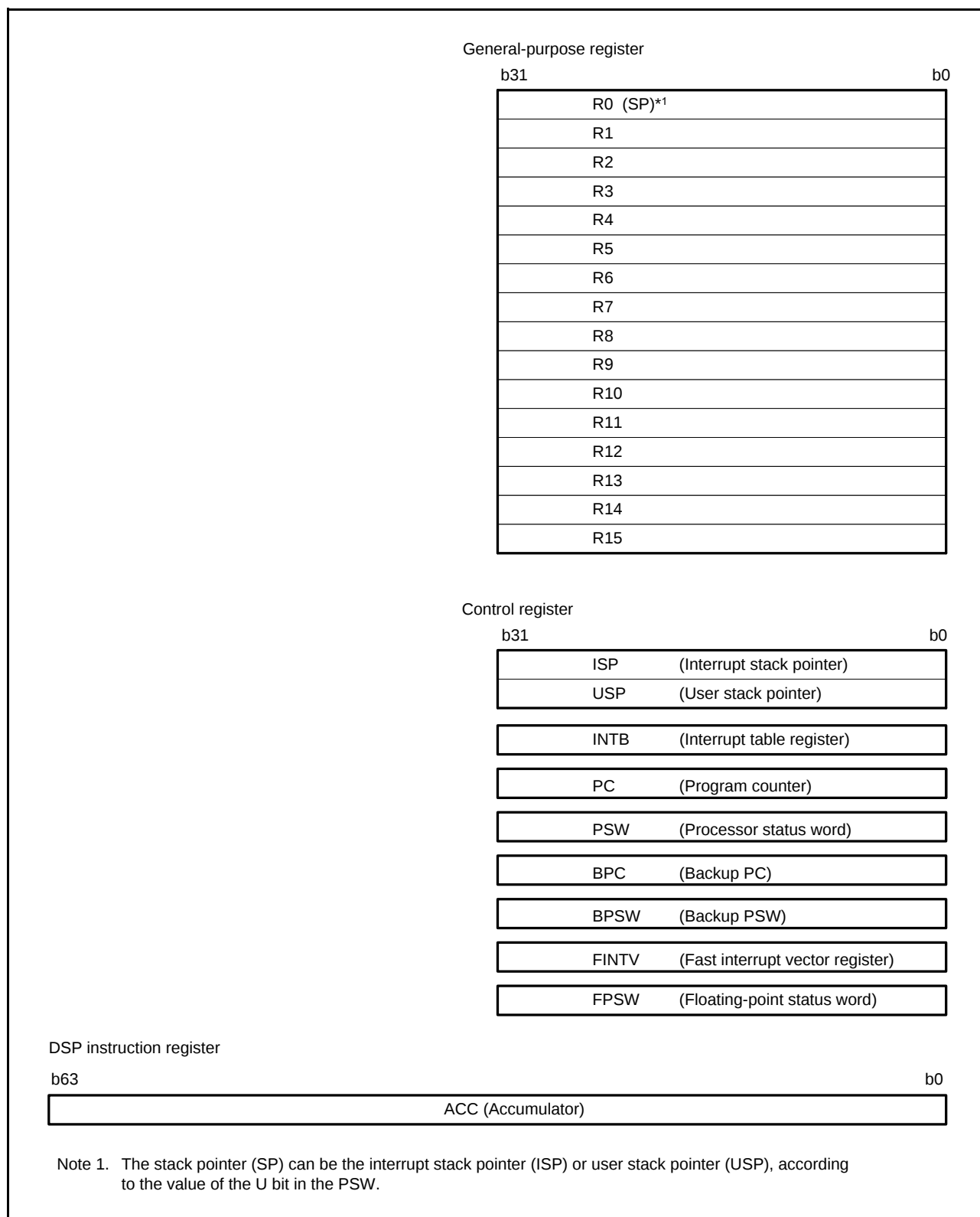


Figure 2.1 Register Set of the CPU

Table 4.1 List of I/O Registers (Address Order) (30/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 C046h	PORT6	Port input data register	PIDR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C047h	PORT7	Port input data register	PIDR	8	8	2, 3 PCLKB	2 ICLK	
0008 C048h	PORT8	Port input data register	PIDR	8	8	2, 3 PCLKB	2 ICLK	
0008 C049h	PORT9	Port input data register	PIDR	8	8	2, 3 PCLKB	2 ICLK	
0008 C04Ah	PORTA	Port input data register	PIDR	8	8	2, 3 PCLKB	2 ICLK	
0008 C04Bh	PORTB	Port input data register	PIDR	8	8	2, 3 PCLKB	2 ICLK	
0008 C04Ch	PORTC	Port input data register	PIDR	8	8	2, 3 PCLKB	2 ICLK	
0008 C04Dh	PORTD	Port input data register	PIDR	8	8	2, 3 PCLKB	2 ICLK	
0008 C04Eh	PORTE	Port input data register	PIDR	8	8	2, 3 PCLKB	2 ICLK	
0008 C04Fh	PORTF	Port input data register	PIDR	8	8	2, 3 PCLKB	2 ICLK	
0008 C050h	PORTG	Port input data register	PIDR	8	8	2, 3 PCLKB	2 ICLK	
0008 C052h	PORTJ	Port input data register	PIDR	8	8	2, 3 PCLKB	2 ICLK	
0008 C060h	PORT0	Port input data register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 C061h	PORT1	Port input data register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 C062h	PORT2	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 C063h	PORT3	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 C064h	PORT4	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 C065h	PORT5	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 C066h	PORT6	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 C067h	PORT7	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 C068h	PORT8	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 C069h	PORT9	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 C06Ah	PORTA	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 C06Bh	PORTB	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 C06Ch	PORTC	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 C06Dh	PORTD	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 C06Eh	PORTE	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 C06Fh	PORTF	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 C070h	PORTG	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 C072h	PORTJ	Port mode register	PMR	8	8	2, 3 PCLKB	2 ICLK	
0008 C080h	PORT0	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C081h	PORT0	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C082h	PORT1	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C083h	PORT1	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C084h	PORT2	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C085h	PORT2	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C086h	PORT3	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C087h	PORT3	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C088h	PORT4	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C089h	PORT4	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C08Ah	PORT5	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C08Bh	PORT5	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C08Ch	PORT6	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C08Dh	PORT6	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C08Eh	PORT7	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C08Fh	PORT7	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C090h	PORT8	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C091h	PORT8	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C092h	PORT9	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C093h	PORT9	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C094h	PORTA	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	

Table 4.1 List of I/O Registers (Address Order) (40/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
000A 0054h	USB0	USB request type register	USBREQ	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	
000A 0056h	USB0	USB request value register	USBVAL	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	
000A 0058h	USB0	USB request index register	USBINDX	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	
000A 005Ah	USB0	USB request length register	USBLENG	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	
000A 005Ch	USB0	DCP configuration register	DCPCFG	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	
000A 005Eh	USB0	DCP maximum packet size register	DCPMAXP	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	
000A 0060h	USB0	DCP control register	DCPCTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	
000A 0064h	USB0	Pipe window select register	PIPESEL	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	USBa
000A 0068h	USB0	Pipe configuration register	PIPECFG	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	
000A 006Ch	USB0	Pipe maximum packet size register	PIPEMAXP	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	

Table 5.4 DC Characteristics (3) (for D and G Versions (-40 ≤ Ta ≤ +85°C))

Conditions: VCC = AVCC0 = VREFH = VCC_USB = V_{BATT} = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0,
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V, T_a = T_{opr}

Item				Symbol	Min.	Typ.	Max.	Unit	Test Conditions		
Supply current*1	High-speed operating mode	Max.*2		I _{CC} *3	—	—	100	mA	ICLK = 100 MHz PCLKA = 100MHz PCLKB = 50 MHz FCLK = 50 MHz BCLK = 100MHz		
		Normal*4	Peripheral function: clock signal supplied*4		—	52	—				
			Peripheral function: clock signal stopped*4		—	40	—				
		Sleep mode			—	25	65				
		All-module-clock-stop mode (reference value)			—	20	38				
		Increased by BGO operation*5			—	15	—				
	Low-speed operating mode 1*6				—	4	—				ICLK = 1 MHz
	Low-speed operating mode 2				—	1	—				ICLK = 32.768 kHz
	Software standby mode				—	0.2	6				
	Deep software standby mode	Power supplied to RAM and USB resume detecting unit			—	22	200			μA	
		Power not supplied to RAM and USB resume detecting unit	Power-on reset circuit and low-power consumption function disabled	—	21	60					
			Power-on reset circuit and low-power	—	6.2	28					
		Increase when the RTC is operating	When a crystal oscillator for low clock loads is in use	—	1.0	—					
			When a crystal oscillator for standard clock loads is in use	—	3.0	—					
		RTC operating while VCC is off (with the battery backup function, only the RTC and sub-clock oscillator operate)	When a crystal oscillator for low clock loads is in use	—	0.9	—	V _{BATT} = 2.0 V, VCC = 0V				
	When a crystal oscillator for standard clock loads is in use		—	1.6	—	V _{BATT} = 3.3 V, VCC = 0V					
			—	1.7	—	V _{BATT} = 2.0 V(for products with 100 pins or more), VBATT = 2.3 V (for the 64-pin product), VCC = 0V					
			—	3.3	—	V _{BATT} = 3.3 V, VCC = 0V					
	Analog power supply current*7	During 12-bit A/D conversion (including temperature sensor)			I _{AVCC0}	—	2.3	3.2	mA		
		During 10-bit A/D conversion			I _{VREFH} *9	—	1.0	1.65	mA		
During D/A conversion (per unit)			—	0.7		1.0	mA				
Waiting for A/D, D/A conversion (all units)*10			—	—	25	35	μA				
A/D, D/A converter in standby mode (all units)*10				—	0.1	4.0	μA				
Reference power supply current	During 12-bit A/D conversion			I _{VREFH0}	—	0.6	0.7	mA			
	Waiting for 12-bit A/D conversion (per unit)				—	0.5	0.6	mA			
	12-bit A/D converter in standby mode (per unit)				—	0.1	2.0	μA			

Table 5.5 DC Characteristics (4) (for G Version (+85 < Ta ≤ +105°C))

Conditions: VCC = AVCC0 = VREFH = VCC_USB = V_{BATT} = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0,
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V, T_a = T_{opr}

Item			Symbol	Min.	Typ.	Max.	Unit	Test Conditions		
Supply current*1	High-speed operating mode	Max.*2		I _{CC} *3	—	—	115	mA	ICLK = 100 MHz PCLKA = 100MHz PCLKB = 50 MHz FCLK = 50 MHz BCLK = 100MHz	
		Normal*4	Peripheral function: clock signal supplied*4		—	52	—			
			Peripheral function: clock signal stopped*4		—	40	—			
		Sleep mode			—	25	80			
		All-module-clock-stop mode (reference value)			—	20	53			
		Increased by BGO operation*5			—	15	—			
	Low-speed operating mode 1*6		—		4	—	ICLK = 1 MHz			
	Low-speed operating mode 2		—		1	—	ICLK = 32.768 kHz			
	Software standby mode		—		0.2	9				
	Deep software standby mode	Power supplied to RAM and USB resume detecting unit			—	22	200	μA		
		Power not supplied to RAM and USB resume detecting unit	Power-on reset circuit and low-power consumption function disabled		—	21	60			
			Power-on reset circuit and low-power consumption function enabled		—	6.2	28			
		Increase when the RTC is operating	When a crystal oscillator for low clock loads is in use		—	1.0	—			
			When a crystal oscillator for standard clock loads is in use		—	3.0	—			
		RTC operating while VCC is off (with the battery backup function, only the RTC and sub-clock oscillator operate)	When a crystal oscillator for low clock loads is in use		—	0.9	—		V _{BATT} = 2.0 V, VCC = 0V	
					—	1.6	—		V _{BATT} = 3.3 V, VCC = 0V	
			When a crystal oscillator for standard clock loads is in use		—	1.7	—		V _{BATT} = 2.0 V(for products with 100 pins or more), VBATT = 2.3 V (for the 64-pin product), VCC = 0V	
					—	3.3	—		V _{BATT} = 3.3 V, VCC = 0V	
Analog power supply current*7	During 12-bit A/D conversion (including temperature sensor)		I _{AVCC0}	—	2.3	3.2	mA			
	During 10-bit A/D conversion		I _{VREFH} *9	—	1.0	1.65				
	During D/A conversion (per unit)			—	0.7	1.0				
	Waiting for A/D, D/A conversion (all units)*10		—	—	25	35		μA		
	A/D, D/A converter in standby mode (all units)*10			—	0.1	5		μA		
Reference power supply current	During 12-bit A/D conversion		I _{VREFH0}	—	0.6	0.7	mA			
	Waiting for 12-bit A/D conversion (per unit)			—	0.5	0.6				
	12-bit A/D converter in standby mode (per unit)			—	0.1	2.0		μA		
RAM standby voltage			V _{RAM}	2.7	—	—	V			
VCC rising gradient			SrVCC	8.4	—	20000	μs/V			
VCC falling gradient*8			SfVCC	8.4	—	—	μs/V			

Table 5.10 Operation Frequency Value (Low-Speed Operating Mode 2)

Conditions: $V_{CC} = AVCC0 = VREFH = V_{CC_USB} = V_{BATT} = 2.7$ to 3.6 V, $VREFH0 = 2.7$ V to $AVCC0$,
 $VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0$ V, $T_a = T_{opr}$

Item			Symbol	Min.	Typ.	Max.	Unit
Operation frequency	System clock (ICLK)		f	32	—	143.75	kHz
	Peripheral module clock (PCLKA)			—	—	143.75	
	Peripheral module clock (PCLKB)			—	—	143.75	
	FlashIF clock (FCLK)			32	—	143.75	
	External bus clock (BCLK)	Packages with 177 to 144 pins		—	—	143.75	
		Packages with 100 pins or less		—	—	143.75	
	BCLK pin output	Packages with 177 to 144 pins		—	—	143.75	
		Packages with 100 pins or less		—	—	143.75	
	SDRAM clock (SDCLK)	Packages with 177 to 144 pins only		—	—	143.75	
	SDCLK pin output	Packages with 177 to 144 pins only		—	—	143.75	
	USB clock (UCLK)			—	—	143.75	
IEBUS clock (IECLK)		—	—	143.75			

5.3.1 Reset Timing

Table 5.11 Reset Timing

Conditions: $V_{CC} = AVCC0 = VREFH = V_{CC_USB} = V_{BATT} = 2.7$ to 3.6 V, $VREFH0 = 2.7$ V to $AVCC0$,
 $VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0$ V, $T_a = T_{opr}$

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
RES# pulse width	Power-on	t_{RESWP}	2	—	—	ms	Figure 5.1
	Deep software standby mode	t_{RESWD}	1	—	—	ms	Figure 5.2
	Software standby mode, low-speed operating mode 2	t_{RESWS}	1	—	—	ms	
	Programming or erasure of the ROM or E2 data-flash memory or blank checking of the E2 DataFlash memory	t_{RESW}	200	—	—	μ s	
	Other than above	t_{RESW}	200	—	—	μ s	
Wait time after RES# cancellation		t_{RESWT}	59	—	60	t_{cyc}	Figure 5.1
Internal reset time (independent watchdog timer reset, watchdog timer reset, software reset)		t_{RESW2}	112	—	120	t_{cyc}	

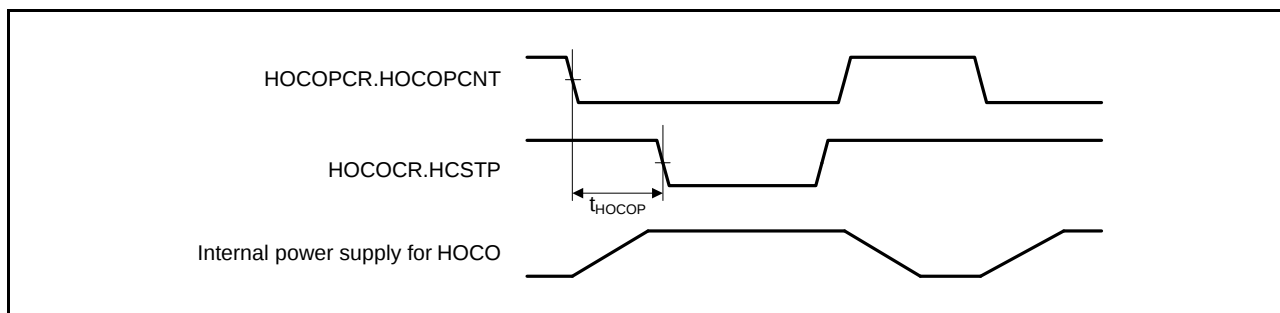


Figure 5.9 HOCO Power Supply Control Timing

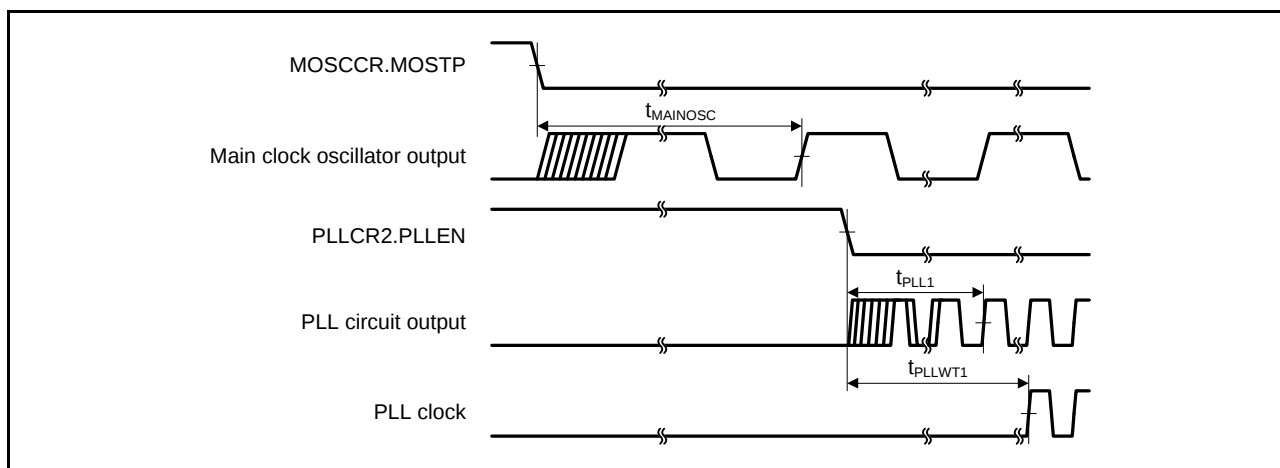


Figure 5.10 PLL Clock Oscillation Start Timing (PLL is Operated after Main Clock Oscillation Has Settled)

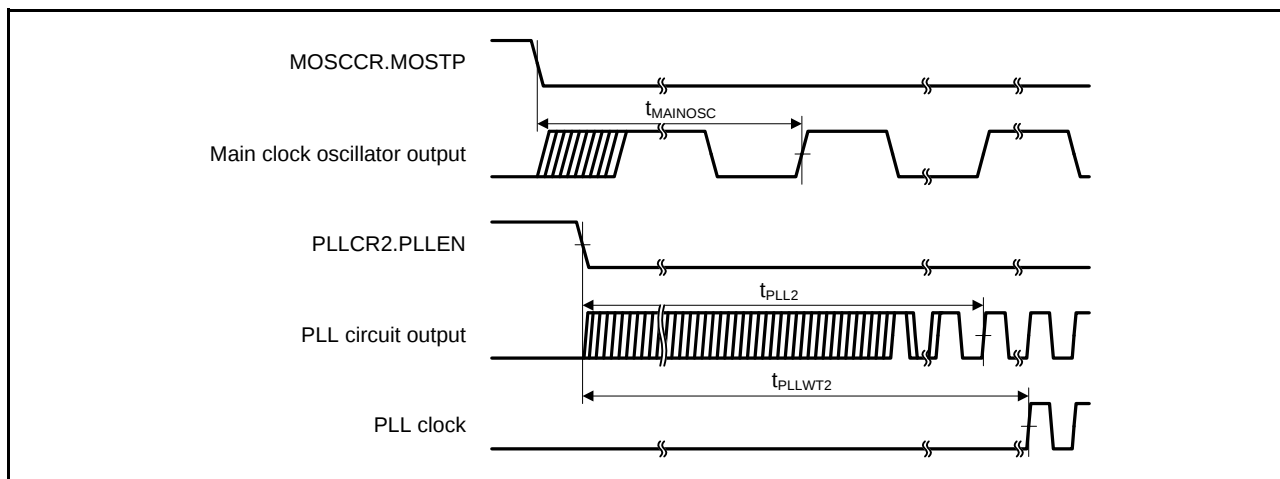
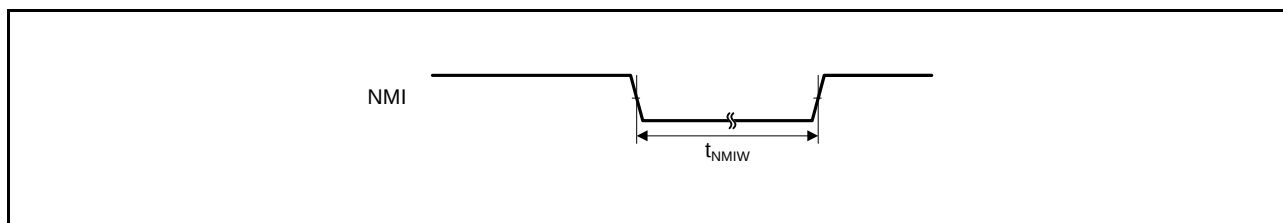
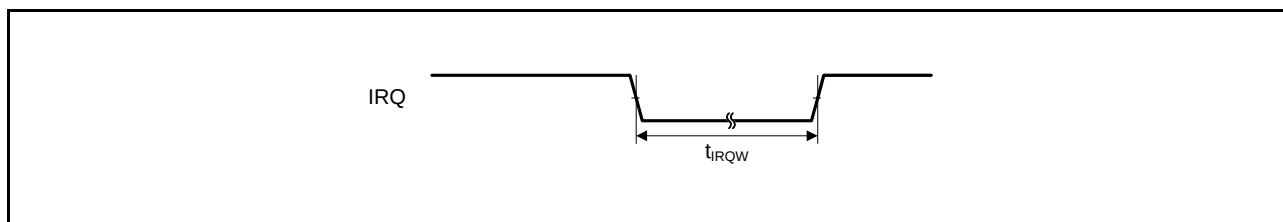


Figure 5.11 PLL Clock Oscillation Start Timing (PLL is Operated before Main Clock Oscillation Has Settled)

**Figure 5.15** NMI Interrupt Input Timing**Figure 5.16** IRQ Interrupt Input Timing

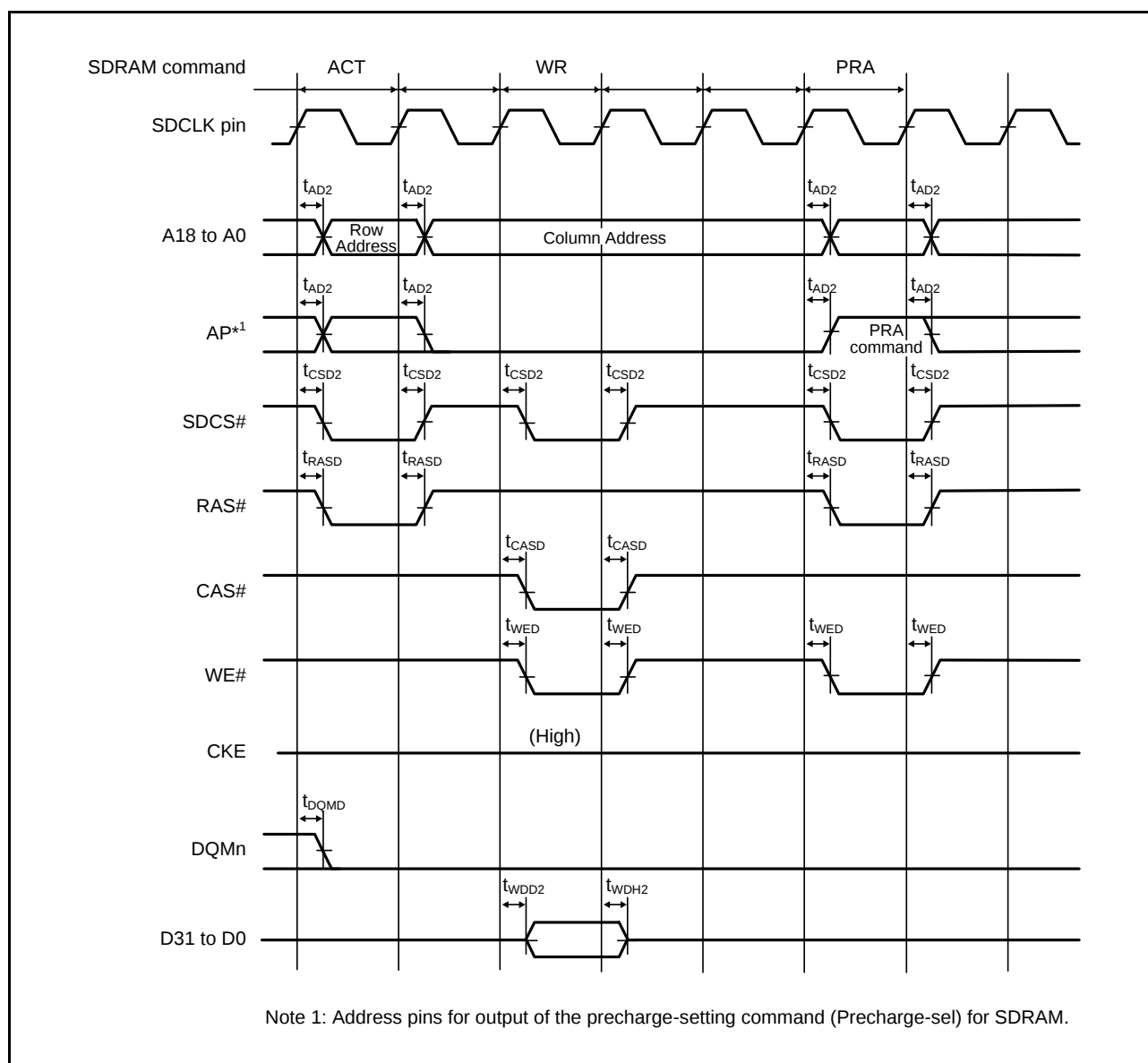


Figure 5.25 SDRAM Space Single Write Bus Timing

Table 5.20 Timing of On-Chip Peripheral Modules (2)

Conditions: $V_{CC} = AV_{CC0} = V_{REFH} = V_{CC_USB} = 2.7$ to 3.6 V*1, $V_{REFH0} = 2.7$ V to AV_{CC0} *1,
 $V_{SS} = AV_{SS0} = V_{REFL}/V_{REFL0} = V_{SS_USB} = 0$ V,
 $PCLK = 8$ to 50 MHz,
 $T_a = T_{opr}$
 High drive output is selected by the drive capacity control register.

Item				Symbol	Min.	Max.	Unit*2	Test Conditions
RSPI	RSPCK clock cycle	Master		t_{SPCyc}	2	4096	t_{Pcyc}	Figure 5.42 C = 30pF
		Slave			8	4096		
	RSPCK clock high pulse width	Master		t_{SPCKWH}	$(t_{SPCyc} - t_{SPCKR} - t_{SPCKF}) / 2 - 3$	—	ns	
		Slave			$(t_{SPCyc} - t_{SPCKR} - t_{SPCKF}) / 2$	—		
	RSPCK clock low pulse width	Master		t_{SPCKWL}	$(t_{SPCyc} - t_{SPCKR} - t_{SPCKF}) / 2 - 3$	—	ns	
		Slave			$(t_{SPCyc} - t_{SPCKR} - t_{SPCKF}) / 2$	—		
	RSPCK clock rise/fall time	Output [packages with 177 to 144 pins]		t_{SPCKr} , t_{SPCKf}	—	5	ns	
		Output [packages with 100 pins or less]			—	10		
		Input			—	1	μs	
	Data input setup time	Master [packages with 177 to 144 pins]	VCC ≥ 3.0 V	t_{SU}	15	—	ns	Figure 5.43 to Figure 5.46 C = 30pF
			VCC < 3.0 V		20	—		
		Master [packages with 100 pins or less]			30	—		
		Slave			$20 - t_{Pcyc}$	—		
	Data input hold time	Master		t_H	0	—	ns	
		Slave			$20 + 2 \times t_{Pcyc}$	—		
	SSL setup time	Master		t_{LEAD}	1	8	t_{SPcyc}	
		Slave			4	—	t_{Pcyc}	
	SSL hold time	Master		t_{LAG}	1	8	t_{SPcyc}	
		Slave			4	—	t_{Pcyc}	

Note 1. When operation at 3.0 V or a lower voltage is needed, please contact a Renesas sales office.

Note 2. t_{PCyc} : PCLK cycle

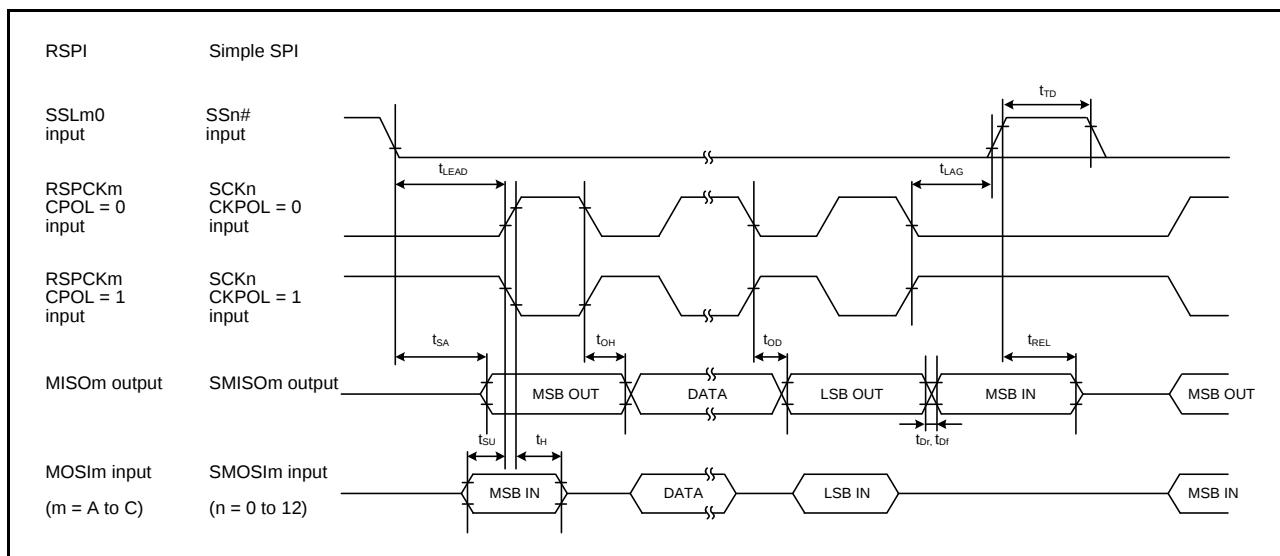


Figure 5.45 RSPi Timing (Slave, CPHA = 0) and Simple SPI Timing (Slave, CKPH = 1)

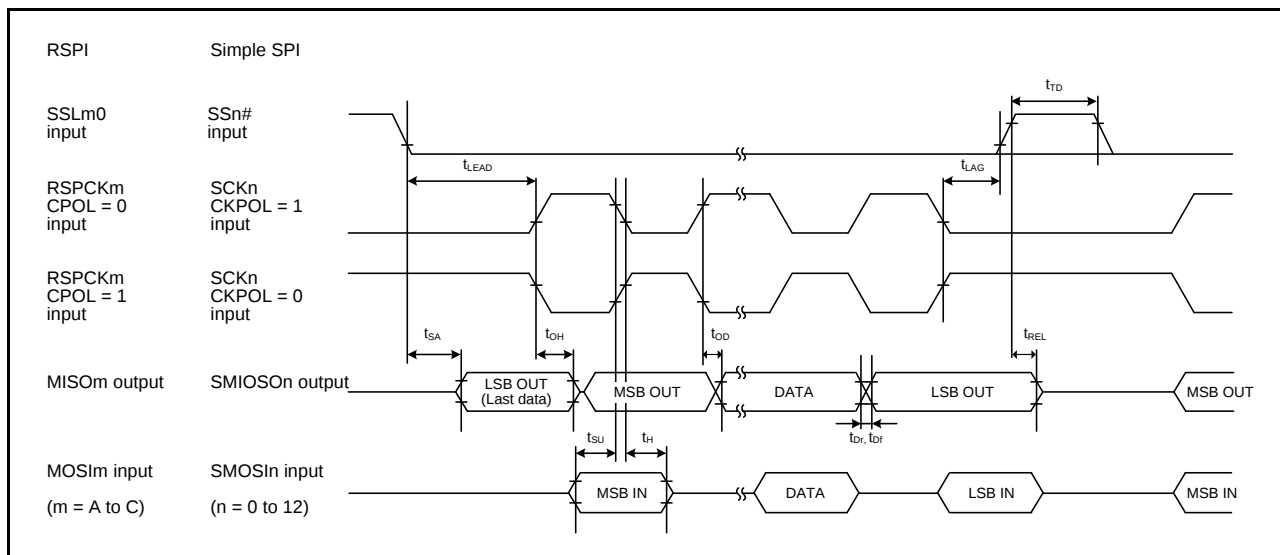


Figure 5.46 RSPi Timing (Slave, CPHA = 1) and Simple SPI Timing (Slave, CKPH = 0)

5.6 D/A Conversion Characteristics

Table 5.31 D/A Conversion Characteristics

Conditions: $VCC = AVCC0 = VREFH = VCC_USB = 2.7$ to 3.6 V, $VREFH0 = 2.7$ V to VCC

$VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0$ V

$T_a = T_{opr}$

Item	Min.	Typ.	Max.	Unit	Test Conditions
Resolution	10	10	10	Bit	
Conversion time	—	—	3.0	μ s	20-pF capacitive load
Absolute accuracy	—	± 2.0	± 4.0	LSB	2-M Ω resistive load
	—	—	± 3.0	LSB	4-M Ω resistive load
	—	—	± 2.0	LSB	10-M Ω resistive load
RO output resistance	—	3.6	—	k Ω	

5.7 Temperature Sensor Characteristics

Table 5.32 Temperature Sensor Characteristics

Conditions: $VCC = AVCC0 = VREFH = VCC_USB = 2.7$ to 3.6 V, $VREFH0 = 2.7$ V to VCC

$VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0$ V

$T_a = T_{opr}$

Item	Min.	Typ.	Max.	Unit	Test Conditions
Relative accuracy	—	± 1	—	$^{\circ}$ C	
Temperature slope	—	4.1	—	mV/ $^{\circ}$ C	
Output voltage (@25 $^{\circ}$ C)	—	1.26	—	V	
Temperature sensor start time	—	—	30	μ s	
Sampling time	—	—	5	μ s	

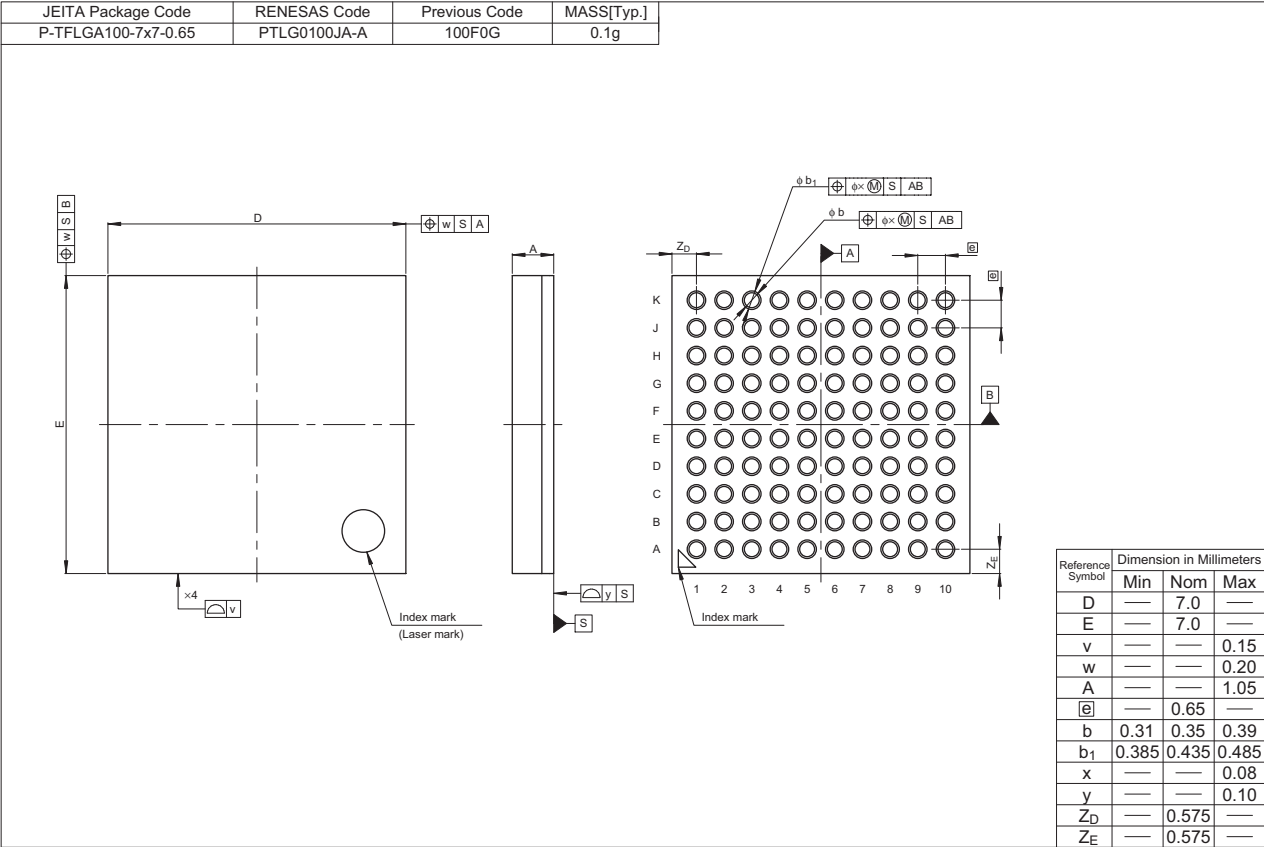


Figure F 100-pin TFLGA (PTLG0100JA-A)